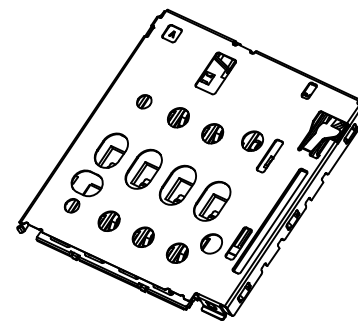
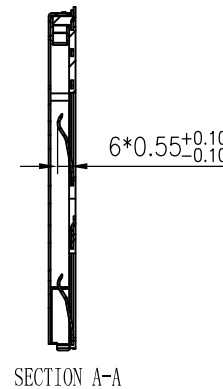
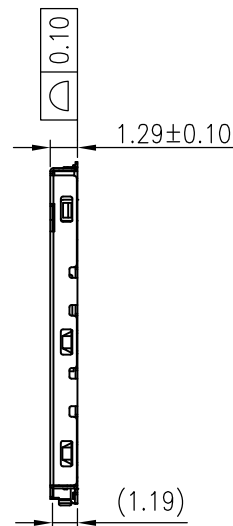
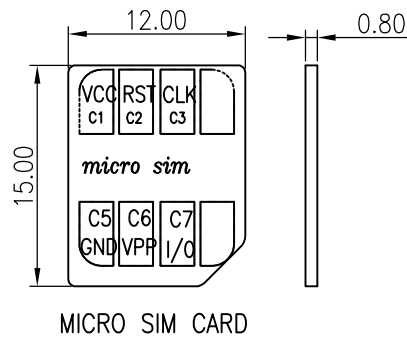
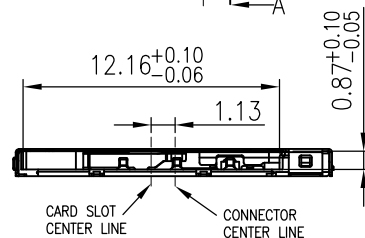
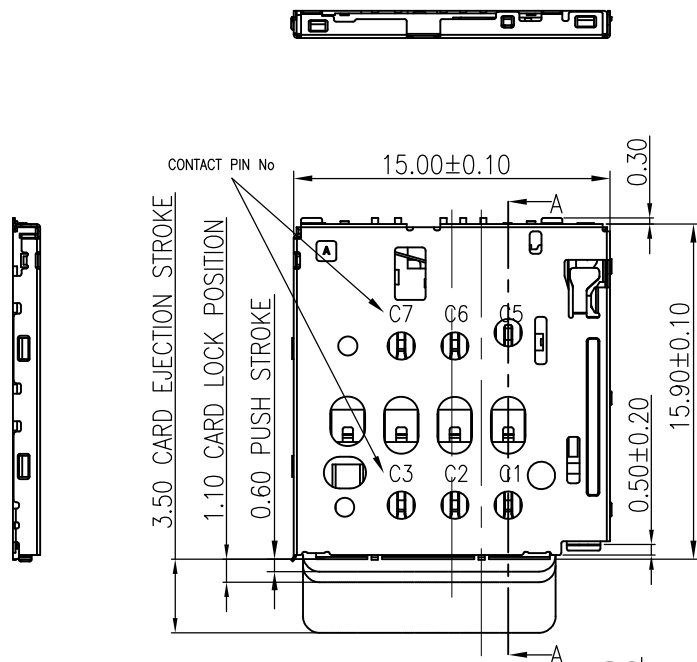
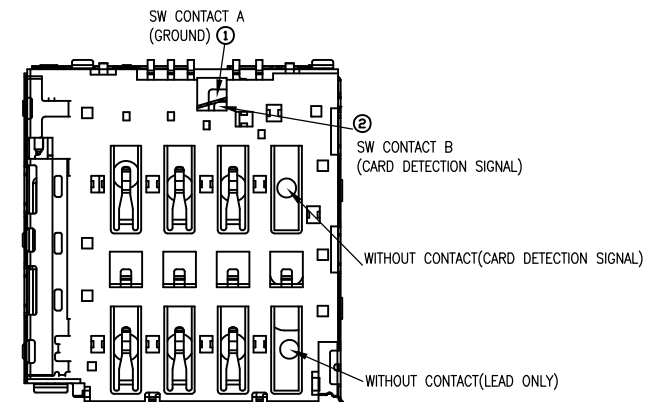


15

REV.	EC#	DESCRIPTION	DATE	DRAWING	CHECKED	APPROVED
X0		新版发行	2017.11.10	HFL	HFL	HAIYONG



3D REFERENCE MODEL



NOTES:

MATERIAL:

Housing: High Temperature Thermoplastic, UL 94V-0.

Contact: Copper Alloy

Shell: SUS

PLATING:

Contact: Contact Area: Au 1u", Solder area: Gold Flash;

Under plate Ni 40u"Min all over

Shell: Plated 30u" Ni Overall

Solder area: Gold Flash

Electrical:

Current Rating :0.5mA max.

Voltage Rating :50V DC MAX

Ambient Temperature Range : -20°C~+85°C

Storage Temperature Range : $-40^{\circ}\text{C} \sim +70^{\circ}\text{C}$

Ambient Humidity Range :95% R.H. Max.

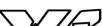
Contact Resistance: 100mΩ max.

Insulation Resistance: 1000MΩ min./250V DC

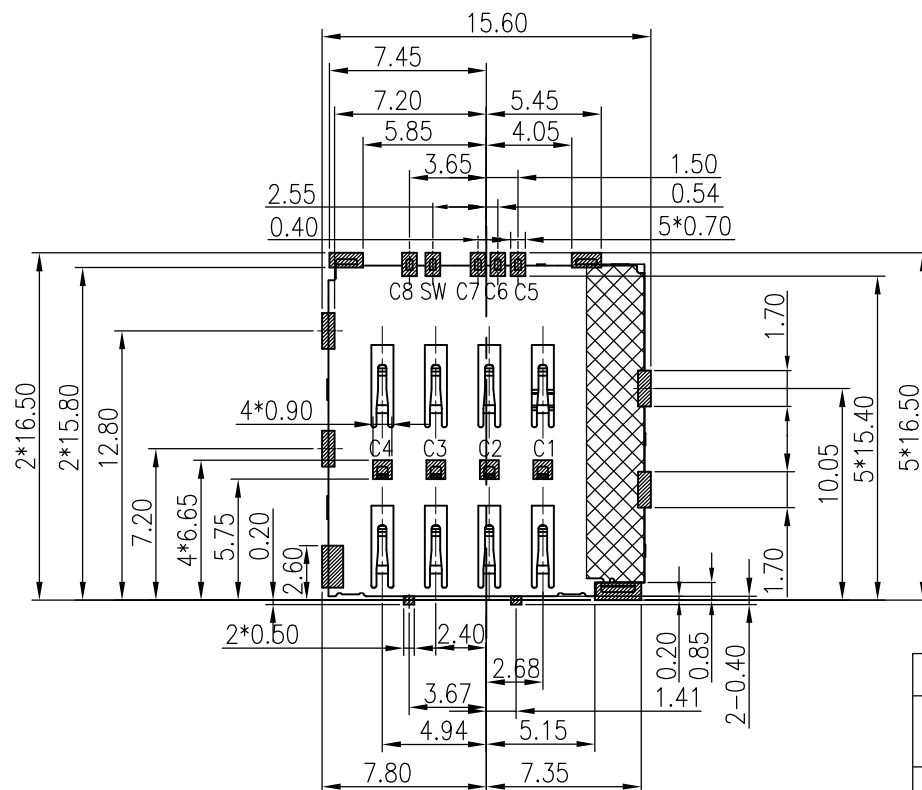
Dielectric Withstanding Voltage:500V AC
Mating Cycles:5,000 Insertions

Mating Cycles:5,000 Insertions
Temperature:2260°C ±5°

Temperature: 260 C 3

MILLIMETERS	INCH	UNITS MM	 东莞市溪榜电子有限公司 DONG GUAN XI BANG ELECTRONICS CO., LTD.										
X° ± 2'	X° ±	MAT'L	PART NUMBER: XB-102012062		TITLE: MICRO-SIM PUSH/PUSH 1.29卡座客户图								
.X ± 0.30	.XX ±	SEE NOTES											
.XX ± 0.20	.XXX ±	FINISH	APPD:		DWG NO.: C-102012062-00								
.XXX± 0.10	.XXXX±	SEE NOTES	CHKD:										
		QTY	DR:		 <table><tr><td>SCALE</td><td>SHEET</td><td>REV.</td></tr><tr><td>1:1</td><td>1/3</td><td>XO</td></tr></table>			SCALE	SHEET	REV.	1:1	1/3	XO
		SCALE	SHEET	REV.									
1:1	1/3	XO											
		SEE NOTES											

RoHS



RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ± 0.05

■ CIRCUT TRACE KEEP OUT AREA
▨ SMT SOLDER AREA

SIM pin Assignment	
PIN#	Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O

CARD INSERTION STATE		CARD DETECT SW
CARD UN-INSERTION	CLOSE	● ② SW CONTACT B (CARD DETECTION SIGNAL)
		● ① SW CONTACT A (USE ONLE)
CARD INSERTION	OPEN	● ② SW CONTACT B (CARD DETECTION SIGNAL)
		● ① SW CONTACT A (USE ONLE)

MILLIMETERS	INCH	UNITS	 东莞市溪榜电子有限公司 DONG GUAN XI BANG ELECTRONI CS CO., LTD			
X° ± 2°	X° ±	MM				
.X ± 0.30	.XX ±	MAT'L	PART NUMBER:		TITLE:	
.XX ± 0.20	.XXX ±	SEE NOTES	XB-102012062		MICRO-SIM PUSH/PUSH 1.29卡座客户图	
.XXX± 0.10	.XXXX±	FINISH	APPD:		DWG NO.:	
		SEE NOTES	CHKD:		C-102012062-00	
		QTY	DR:			
		SEE NOTES			SCALE	SHEET
					1:1	2/3
					REV.	X0